

STARPOWER

SEMICONDUCTOR

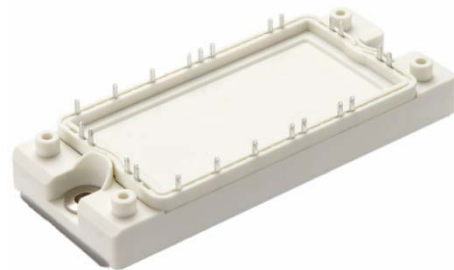
IGBT

GD50PIT120C5SN_G8

Molding Type Module**1200V/50A PIM in one-package**

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175 $^{\circ}$ C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

IGBT-inverter $T_C=25^{\circ}\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD50PIT120C5SN_G8	Units
V_{CES}	Collector-Emitter Voltage @ $T_j=25^{\circ}\text{C}$	1200	V
V_{GES}	Gate-Emitter Voltage @ $T_j=25^{\circ}\text{C}$	± 30	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$ @ $T_C=100^{\circ}\text{C}$	100 50	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	100	A
P_{tot}	Total Power Dissipation @ $T_j=175^{\circ}\text{C}$	285	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^{\circ}\text{C}$	1200			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V},$ $T_j=25^{\circ}\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V},$ $T_j=25^{\circ}\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=2.0\text{mA}, V_{CE}=V_{GE},$ $T_j=25^{\circ}\text{C}$	5.0		6.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=50\text{A}, V_{GE}=15\text{V},$ $T_j=25^{\circ}\text{C}$		1.70	2.15	V
		$I_C=50\text{A}, V_{GE}=15\text{V},$ $T_j=175^{\circ}\text{C}$		2.10		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=50A,$ $R_G=15\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		200		ns
t_r	Rise Time			43		ns
$t_{d(off)}$	Turn-Off Delay Time			266		ns
t_f	Fall Time			295		ns
E_{on}	Turn-On Switching Loss			3.01		mJ
E_{off}	Turn-Off Switching Loss			3.35		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=50A,$ $R_G=15\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		200		ns
t_r	Rise Time			47		ns
$t_{d(off)}$	Turn-Off Delay Time			280		ns
t_f	Fall Time			400		ns
E_{on}	Turn-On Switching Loss			3.62		mJ
E_{off}	Turn-Off Switching Loss			5.10		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz,$ $V_{GE}=0V$		4.50		nF
C_{res}	Reverse Transfer Capacitance			0.15		nF
Q_G	Gate Charge	$V_{CC}=600V, I_C=50A,$ $V_{GE}=15V$		300		nC
I_{SC}	SC Data	$t_p \leq 10\mu s, V_{GE}=15V,$ $T_j=125^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		TBD		A

Diode-inverter $T_C=25^\circ C$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD50PIT120C5SN_G8	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^\circ C$	1200	V
I_F	DC Forward Current	50	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1ms$	100	A

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V _F	Diode Forward Voltage	I _F =50A, V _{GE} =0V	T _J =25℃		1.70	2.10	V
			T _J =125℃		1.65		
Q _r	Recovered Charge	I _F =50A, V _R =600V, R _G =15Ω, V _{GE} =-15V	T _J =25℃		3.0		μC
			T _J =125℃		7.2		
I _{RM}	Peak Reverse Recovery Current		T _J =25℃		46		A
			T _J =125℃		56		
E _{rec}	Reverse Recovery Energy		T _J =25℃		2.00		mJ
			T _J =125℃		3.50		

Diode-rectifier $T_C=25^{\circ}\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD50PIT120C5SN_G8	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_J=25^{\circ}\text{C}$	1600	V
$I_{F(AV)}$	Average On-state Current @ $T_C=80^{\circ}\text{C}$	50	A
I_{RMSM}	Maximum RMS Current At Rectifier Output @ $T_C=80^{\circ}\text{C}$	80	A
I_{FSM}	Surge Forward Current $V_R=0\text{V}, t_p=10\text{ms}, T_J=45^{\circ}\text{C}$	600	A
I^2t	I^2t -value, $V_R=0\text{V}, t_p=10\text{ms}, T_J=45^{\circ}\text{C}$	1800	A^2s

Characteristics Values

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=50\text{A}$	$T_J=150^{\circ}\text{C}$		1.30		V
I_R	Reverse Current	$T_J=150^{\circ}\text{C}, V_R=1600\text{V}$				3.0	mA

IGBT-brake-chopper $T_C=25^{\circ}\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD50PIT120C5SN_G8	Units
V_{CES}	Collector-Emitter Voltage @ $T_J=25^{\circ}\text{C}$	1200	V
V_{GES}	Gate-Emitter Voltage @ $T_J=25^{\circ}\text{C}$	± 30	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$ @ $T_C=100^{\circ}\text{C}$	50 25	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	50	A
P_{tot}	Total Power Dissipation @ $T_J=175^{\circ}\text{C}$	192	W

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_J=25^{\circ}\text{C}$	1200			V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_J=25^{\circ}\text{C}$			5.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_J=25^{\circ}\text{C}$			400	nA

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=1.0mA, V_{CE}=V_{GE}, T_j=25^{\circ}C$	5.0		6.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=25A, V_{GE}=15V, T_j=25^{\circ}C$		1.70	2.15	V
		$I_C=25A, V_{GE}=15V, T_j=175^{\circ}C$		2.10		

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=25A, R_G=18\Omega, V_{GE}=\pm 15V, T_j=25^{\circ}C$		147		ns
t_r	Rise Time			26		ns
$t_{d(off)}$	Turn-Off Delay Time			201		ns
t_f	Fall Time			337		ns
E_{on}	Turn-On Switching Loss			1.64		mJ
E_{off}	Turn-Off Switching Loss			1.65		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=25A, R_G=18\Omega, V_{GE}=\pm 15V, T_j=125^{\circ}C$		143		ns
t_r	Rise Time			28		ns
$t_{d(off)}$	Turn-Off Delay Time			216		ns
t_f	Fall Time			400		ns
E_{on}	Turn-On Switching Loss			1.93		mJ
E_{off}	Turn-Off Switching Loss			2.38		mJ
C_{ies}	Input Capacitance	$V_{CE}=30V, f=1Mhz, V_{GE}=0V$		2.40		nF
C_{res}	Reverse Transfer Capacitance			0.08		nF
Q_G	Gate Charge	$V_{CC}=600V, I_C=25A, V_{GE}=15V$		180		nC
I_{SC}	SC Data	$t_p \leq 10\mu s, V_{GE}=15V, T_j=125^{\circ}C, V_{CC}=900V, V_{CEM} \leq 1200V$		TBD		A

Diode-brake-chopper $T_C=25^{\circ}\text{C}$ unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD50PIT120C5SN_G8	Units
V_{RRM}	Repetitive Peak Reverse Voltage @ $T_j=25^{\circ}\text{C}$	1200	V
I_F	DC Forward Current	25	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1\text{ms}$	50	A

Characteristics Values

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=25\text{A}, V_{GE}=0\text{V}$	$T_j=25^{\circ}\text{C}$	2.10	2.50	V
			$T_j=125^{\circ}\text{C}$	2.15		
Q_r	Recovered Charge	$I_F=25\text{A},$	$T_j=25^{\circ}\text{C}$	1.3		μC
		$V_R=600\text{V},$	$T_j=125^{\circ}\text{C}$	2.0		
I_{RM}	Peak Reverse Recovery Current	$R_G=18\Omega,$	$T_j=25^{\circ}\text{C}$	31		A
		$V_{GE}=-15\text{V}$	$T_j=125^{\circ}\text{C}$	38		
E_{rec}	Reverse Recovery Energy		$T_j=25^{\circ}\text{C}$	0.68		mJ
			$T_j=125^{\circ}\text{C}$	1.45		

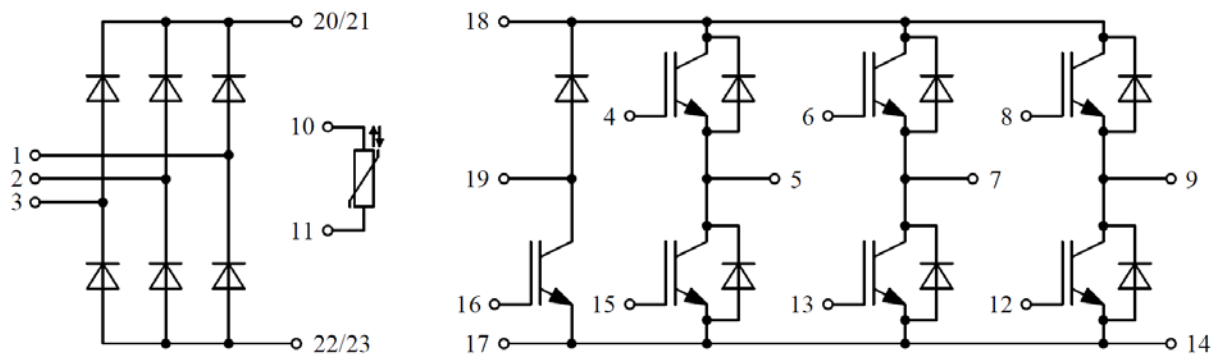
Electrical Characteristics of NTC $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
R_{25}	Rated Resistance			5.0		$\text{k}\Omega$
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K

IGBT Module

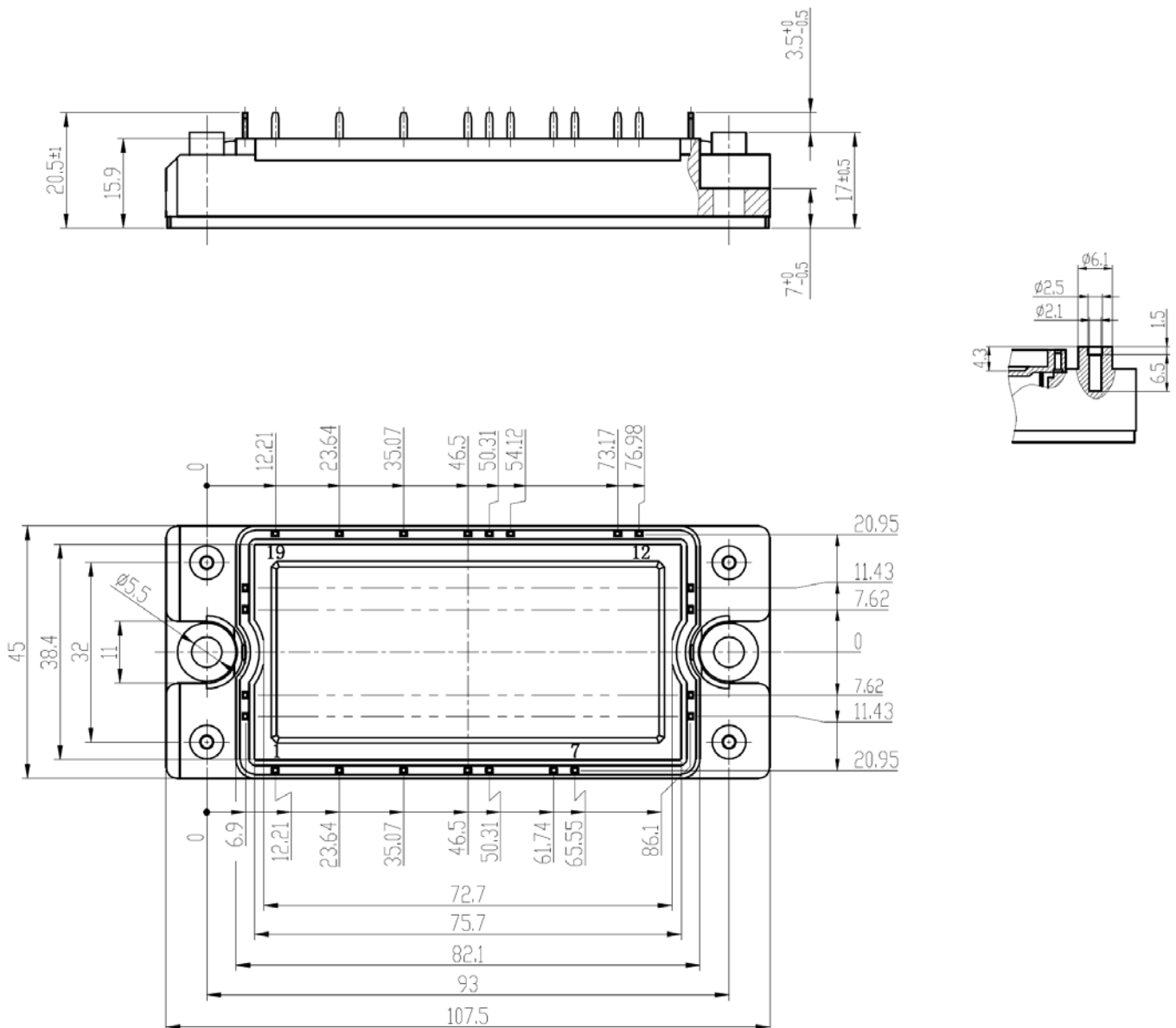
Symbol	Parameter	Min.	Typ.	Max.	Units
V _{ISO}	Isolation Voltage RMS, f=50Hz, t=1min	4000			V
L _{CE}	Stray Inductance		60		nH
R _{CC'+EE'} R _{AA'+CC'}	Module Lead Resistance, Terminal to Chip @ T _C =25℃		4.00 2.00		mΩ
R _{θJC}	Junction-to-Case (per IGBT-inverter)			0.527	K/W
	Junction-to-Case (per Diode-inverter)			0.862	
	Junction-to-Case (per Diode-rectifier)			0.908	
	Junction-to-Case (per IGBT-brake-chopper)			0.780	
	Junction-to-Case (per Diode-brake-chopper)			1.326	
R _{θCS}	Case-to-Sink (Conductive grease applied)		0.02		K/W
T _{jmax}	Maximum Junction Temperature (inverter, brake)			175	℃
	Maximum Junction Temperature(rectifier)			150	
T _{jop}	Operating Junction Temperature (inverter, brake)	-40		150	℃
	Operating Junction Temperature(rectifier)	-40		125	
T _{STG}	Storage Temperature Range	-40		125	℃
M	Mounting Torque, Screw:M5	3.0		6.0	N.m
G	Weight of Module		180		g

Equivalent Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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